

SOT-23 Plastic-Encapsulate Transistors

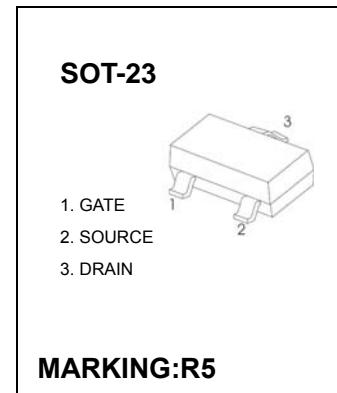
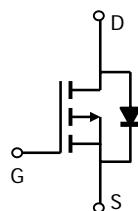
BC3405 P-Channel Enhancement Mode Field Effect Transistor

General Description

The BC3405 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.

Features

- V_{DS} (V) = -30V
- I_D = -2.6 A (V_{GS} = -10V)
- $R_{DS(ON)} < 130m\Omega$ (V_{GS} = -10V)
- $R_{DS(ON)} < 180m\Omega$ (V_{GS} = -4.5V)



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

| Parameter | Symbol | Maximum | Units |
|--|----------------|------------|-------|
| Drain-Source Voltage | V_{DS} | -30 | V |
| Gate-Source Voltage | V_{GS} | ± 12 | V |
| Continuous Drain Current ^A | I_D | -2.6 | A |
| $T_A=70^\circ C$ | | -2.2 | |
| Pulsed Drain Current ^B | I_{DM} | -30 | |
| Power Dissipation ^A | P_D | 1.4 | W |
| $T_A=70^\circ C$ | | 1 | |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Units |
|--|-----------------|-----|-----|-------|
| Maximum Junction-to-Ambient ^A | $R_{\theta JA}$ | 65 | 90 | °C/W |
| Steady-State | | 85 | 125 | °C/W |
| Maximum Junction-to-Lead ^C | $R_{\theta JL}$ | 43 | 60 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|-----------------------------|---------------------------------------|---|------|-------|-----------|------------------|
| STATIC PARAMETERS | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $I_D=-250\mu\text{A}, V_{GS}=0\text{V}$ | -30 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=-24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$ | | -1 | -5 | μA |
| I_{GSS} | Gate-Body leakage current | $V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$ | | | ± 100 | nA |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D=-250\mu\text{A}$ | -1.3 | -1.8 | -2.3 | V |
| $I_{\text{D(ON)}}$ | On state drain current | $V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$ | -10 | | | A |
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance | $V_{GS}=-10\text{V}, I_D=-2.6\text{A}$ $T_J=125^\circ\text{C}$ | | 102 | 130 | $\text{m}\Omega$ |
| | | $V_{GS}=-4.5\text{V}, I_D=-2\text{A}$ | | 137 | 180 | $\text{m}\Omega$ |
| | | | | | | $\text{m}\Omega$ |
| g_{FS} | Forward Transconductance | $V_{DS}=-5\text{V}, I_D=-2.5\text{A}$ | 7 | 11 | | S |
| V_{SD} | Diode Forward Voltage | $I_S=-1\text{A}, V_{GS}=0\text{V}$ | | -0.83 | -1 | V |
| I_S | Maximum Body-Diode Continuous Current | | | | -2.2 | A |
| DYNAMIC PARAMETERS | | | | | | |
| C_{iss} | Input Capacitance | $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$ | | 481 | | pF |
| C_{oss} | Output Capacitance | | | 54 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 34 | | pF |
| R_g | Gate resistance | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$ | | 12 | | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Q_g | Total Gate Charge | $V_{GS}=-4.5\text{V}, V_{DS}=-15\text{V}, I_D=-2.5\text{A}$ | | 1.25 | | nC |
| Q_{gs} | Gate Source Charge | | | 1.75 | | nC |
| Q_{gd} | Gate Drain Charge | | | 4.35 | | nC |
| $t_{\text{D(on)}}$ | Turn-On Delay Time | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=6\Omega, R_{\text{GEN}}=6\Omega$ | | 8.9 | | ns |
| t_r | Turn-On Rise Time | | | 8.8 | | ns |
| $t_{\text{D(off)}}$ | Turn-Off Delay Time | | | 23 | | ns |
| t_f | Turn-Off Fall Time | | | 6.9 | | ns |
| t_{rr} | Body Diode Reverse Recovery Time | $I_F=-2.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 26 | | ns |
| Q_{rr} | Body Diode Reverse Recovery Charge | $I_F=-2.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 15.6 | | nC |

A: The value of R_{QJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R_{QJA} is the sum of the thermal impedance from junction to lead R_{QJL} and lead to ambient.

D. The static characteristics in Figures 1 to 6, 12, 14 are obtained using 80μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

Typical Characteristics

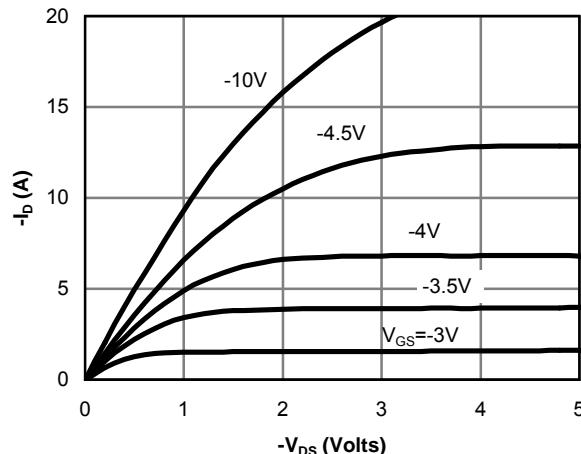


Fig 1: On-Region Characteristics

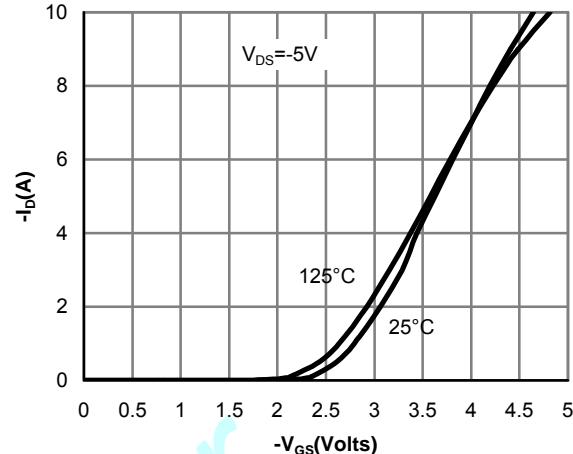


Figure 2: Transfer Characteristics

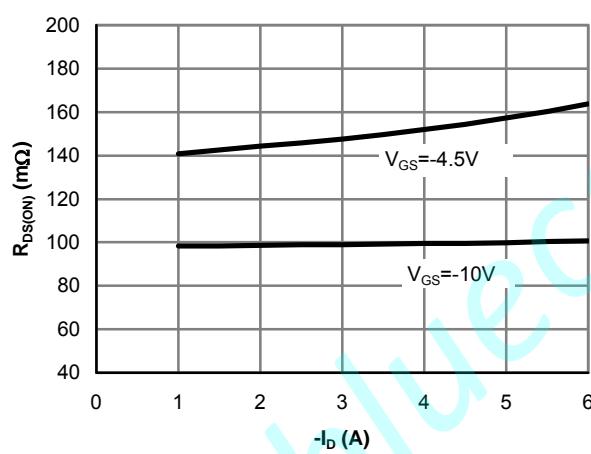


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

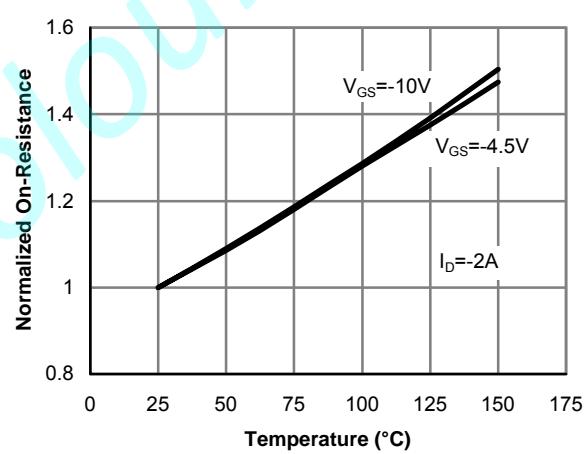


Figure 4: On-Resistance vs. Junction Temperature

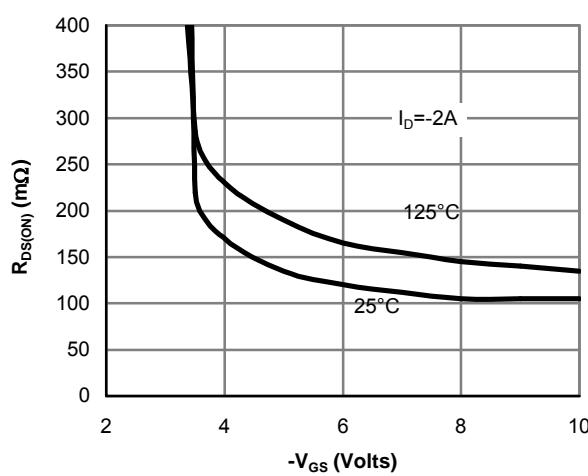


Figure 5: On-Resistance vs. Gate-Source Voltage

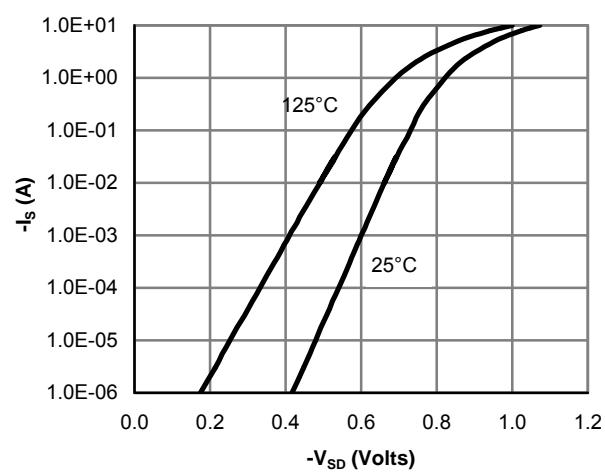
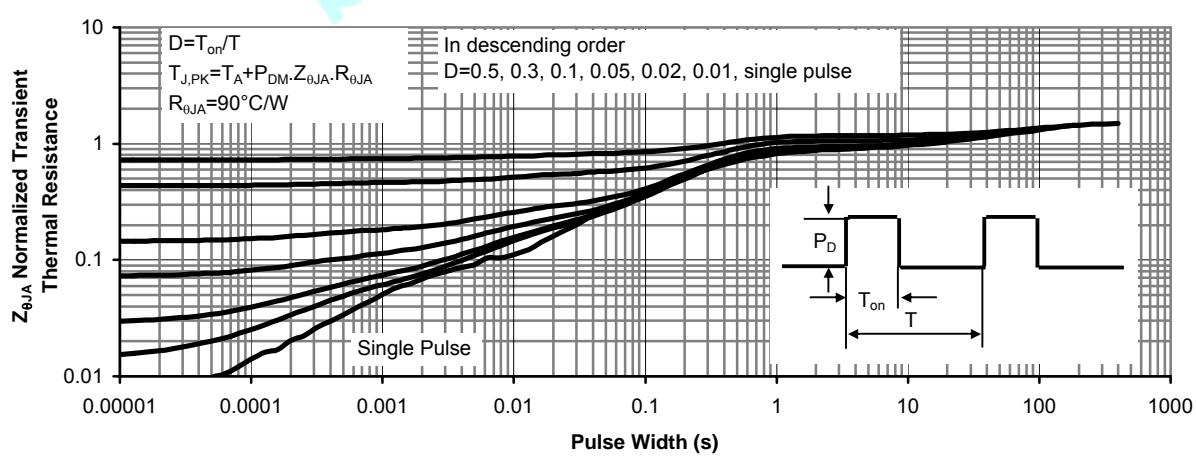
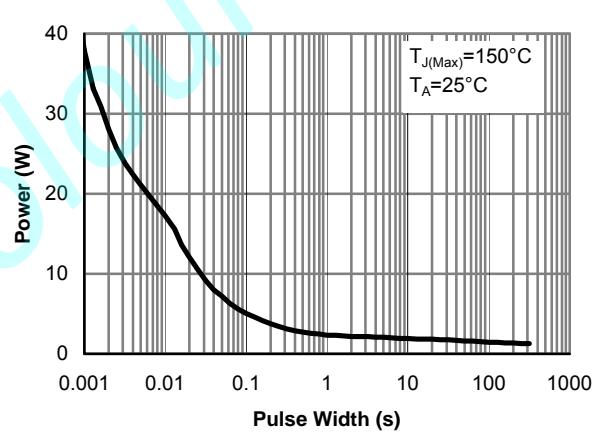
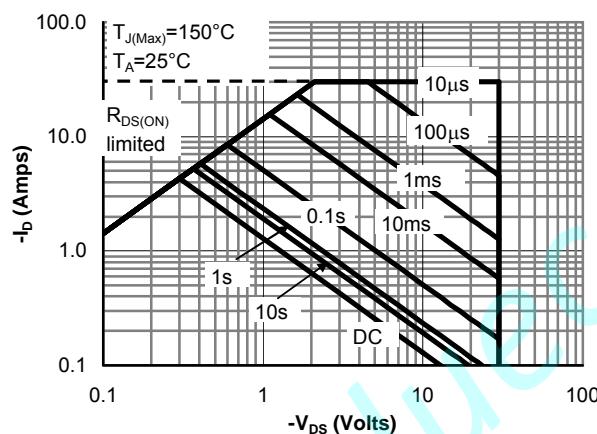
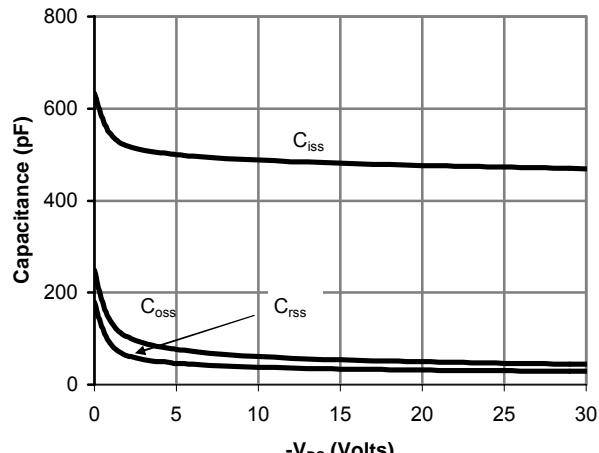
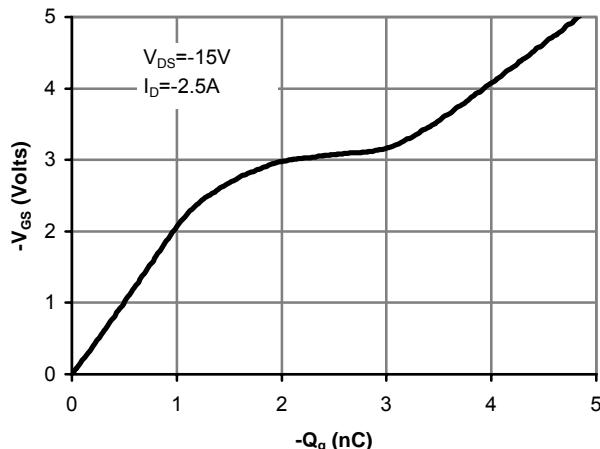


Figure 6: Body-Diode Characteristics

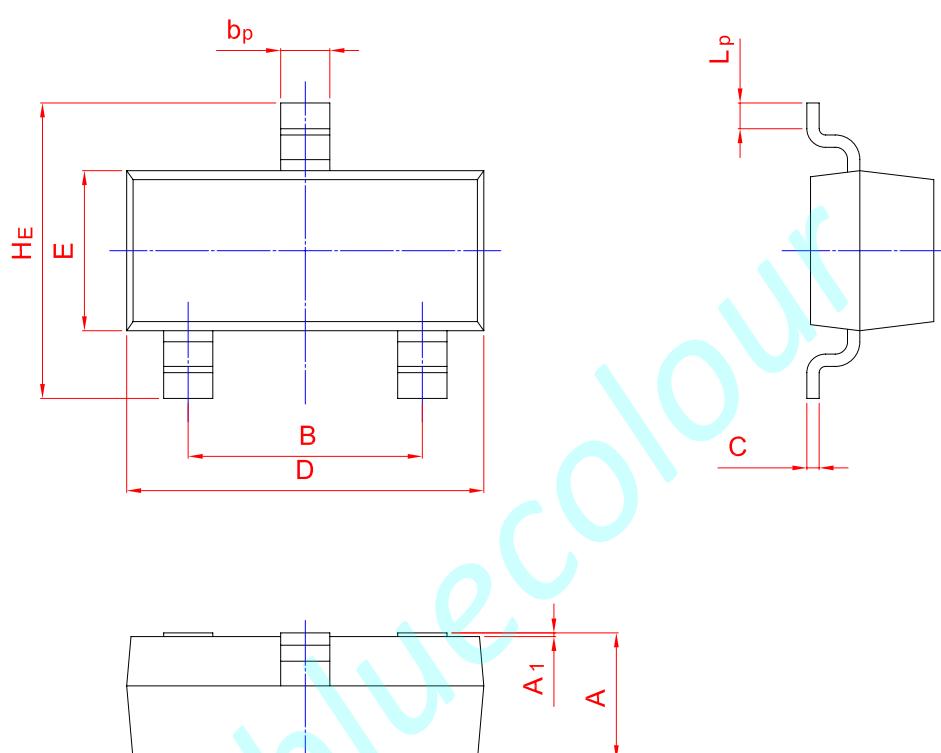
Typical Characteristics



PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



| UNIT | A | B | b_p | C | D | E | H_E | A_1 | L_p |
|------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|----------------|--------------|
| mm | 1.40 0.95 | 2.04 1.78 | 0.50 0.35 | 0.19 0.08 | 3.10 2.70 | 1.65 1.20 | 3.00 2.20 | 0.100 0.013 | 0.50 0.20 |